AMENDMENT TO THE CLAIMS

- 1. (original) An integrated composite base plate and printed circuit board structure for a data storage device comprising:
 - a base plate;
 - a printed circuit board attached to the base plate and spaced therefrom by a gap; and
 - a first adhesive layer between the printed circuit board and the base plate substantially filling the gap and bonding the circuit board and base plate together to form a stiff composite structure for supporting a data storage disc on a drive motor mounted on the base plate.
- 2. (original) The structure according to claim 1 wherein the base plate has an aperture receiving therethrough at least one component mounted on the printed circuit board.
- 3. (original) The structure according to claim 2 further comprising a printed circuit board shield fastened to an underside surface of the printed circuit board by a second adhesive layer between the printed circuit board and the shield.
- 4. (original) The structure according to claim 1 wherein the printed circuit board has a connector fastened thereto and the first adhesive layer bonds the connector to the base plate.
- 5. (original) The structure according to claim 3 wherein an overall thickness of the structure is less than 3.3 mm.
- 6. (original) The structure according to claim 5 wherein the base plate has a portion having a thickness of between 0.2 mm and 0.3 mm.

- 7. (original) An integrated composite base plate and printed circuit board structure for a disc drive comprising:
 - a base plate;
 - a printed circuit board attached to the base plate and spaced therefrom by a gap; and
 - a first adhesive layer between the printed circuit board and the base plate substantially filling the gap and bonding the circuit board and base plate together to form a stiff composite structure for supporting a data storage disc on a drive motor mounted on the base plate, wherein the disc drive has an overall form factor of a Type I compact flash card.
- 8. (original) The structure according to claim 1 wherein the base plate has an aperture receiving therethrough at least one component mounted on the printed circuit board.
- 9. (original) The structure according to claim 2 further comprising a printed circuit board shield fastened to an underside surface of the printed circuit board by a second adhesive layer between the printed circuit board and the shield.
- 10. (original) The structure according to claim 1 wherein the printed circuit board has a connector fastened thereto and the first adhesive layer bonds the connector to the base plate.
- 11. (original) The structure according to claim 3 wherein an overall thickness of the structure is less than 3.3 mm.
- 12. (original) The structure according to claim 5 wherein the base plate has a portion having a thickness of between 0.2 mm and 0.3 mm.
- 13. (currently amended) A structure having a base plate for supporting a disc drive motor and an actuator in a disc drive comprising:

a printed circuit board-assembly; and

- a bonding means filling a gap between the base plate and the printed circuit board for fastening the printed circuit board assembly to the base <u>plate</u> and forming a stiff support structure.
- 14. (original) The structure according to claim 13 wherein the bonding means is a layer of adhesive between the base plate and the printed circuit board.
- 15. (original) The structure according to claim 14 further comprising a printed circuit board shield spaced from the printed circuit board by a gap and another layer of adhesive filling the gap bonding the shield to the printed circuit board.
- 16. (original) The structure according to claim 14 wherein the base plate has an aperture therethrough and said printed circuit board has at least one component projecting into the aperture.
- 17. (original) The structure according to claim 14 wherein the adhesive is an epoxy adhesive.
- 18. (original) The structure according to claim 15 wherein said layers are epoxy adhesive layers.
- 19. (original) The structure according to claim 13 wherein the gap is substantially planar and the bonding means is a layer of epoxy that covers a surface of the printed circuit board and surrounds components mounted on the printed circuit board.
- 20. (original) The structure according to claim 19 wherein the base plate has an aperture therethrough receiving one of the components therein.